GENERAL DESCRIPTION

The 873991 is a low voltage, low skew, 3.3V LVPECL or ECL Clock Generator . The 873991 has two selectable clock inputs. The PCLK, nPCLK pair can accept an LVPECL input and the TEST_CLK pin can accept a LVCMOS or LVT-TL input. This device has a fully integrated PLL along with frequency configurable outputs. An external feedback input and output regenerates clocks with "zero delay".

The four independent banks of outputs each have their own output dividers, which allow the device to generate a multitude of different bank frequency ratios and output-toinput frequency ratios. The output frequency range is 25MHz to 400MHz and the input frequency range is 6.25MHz to 125MHz. The PLL_SEL input can be used to bypass the PLL for test and system debug purposes. In bypass mode, the input clock is routed around the PLL and into the internal output dividers.

The 873991 also has a SYNC output which can be used for system synchronization purposes. It monitors Bank A and Bank C outputs for coincident rising edges and signals a pulse per the timing diagrams in this data sheet. This feature is used primarily in applications where Bank A and Bank C are running at different frequencies, and is particularly useful when they are running at non-integer multiples of each other.

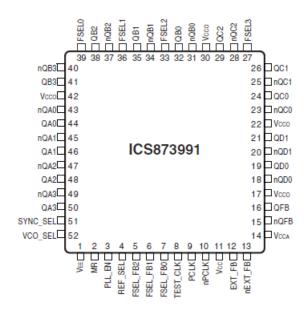
Example Applications:

- 1. Line Card Multiplier: Multiply 19.44MHz from a back-plane to 77.76MHz on the line card ASIC and Serdes.
- 2. Zero Delay Buffer: Fan out up to thirteen 100MHz copies from a reference clock to multiple processing units on an embedded system.

FEATURES

- 14 differential LVPECL outputs
- Selectable differential LVPECL or TEST_CLK inputs
- PCLK, nPCLK can accept the following input levels: LVPECL, CML, SSTL
- TEST_CLK accepts the following input levels: LVCMOS, LVTTL
- Input frequency range: 6.25MHz to 125MHz
- Output frequency: 400MHz (maximum)
- VCO range: 200MHz to 800MHz
- Output skew: 250ps (maximum)
- Cycle-to-cyle jitter: ±50ps (typical)
- LVPECL mode operating voltage supply range: $V_{CC} = 3.135V$ to 3.465V, $V_{FE} = 0V$
- ECL mode operating voltage supply range: $V_{cc} = 0V, V_{EE} = -3.465V$ to -3.135V
- 0°C to 70°C ambient operating temperature
- Industrial temperature available upon request
- · Lead-Free package fully RoHS compliant
- Use replacement part 873996AYLF

PIN ASSIGNMENT



52-Lead LQFP 10mm x 10mm x 1.4mm package body Y package Top View

BLOCK DIAGRAM

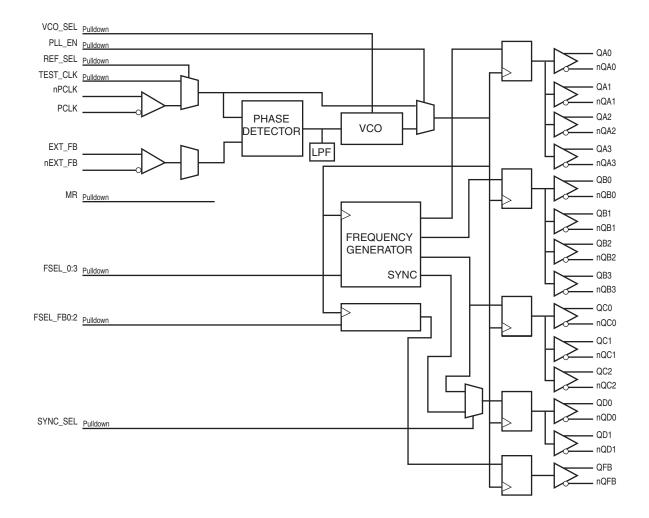


TABLE 1. PIN DESCRIPTIONS

Number	Name	т	уре	Description
1	V _{EE}	Power		Negative supply pin.
2	MR	Input	Pulldown	Active High Master Reset. When logic HIGH, the internal dividers are reset causing the true outputs (Qx) to go low and the inverted outputs (nQx) to go high. When logic LOW, the internal dividers and the outputs are enabled. LVCMOS/LVTTL interface levels.
3	PLL_EN	Input	Pulldown	PLL enable pin. When logic LOW, PLL is enabled. When logic HIGH, PLL is in bypass mode. LVCMOS/LVTTL interface levels.
4	REF_SEL	Input	Pulldown	Selects between the different reference inputs as the PLL reference source. When logic LOW, selects PCLK/nPCLK. When logic HIGH, selects TEST_CLK. LVCMOS/LVTTL interface levels.
5 6 7	FSEL_FB2 FSEL_FB1 FSEL_FB0	Input	Pulldown	Feedback frequency select pins. LVCMOS/LVTTL interface levels.
8	TEST_CLK	Input	Pulldown	LVCMOS/LVTTL test clock input.
9	PCLK	Input	Pulldown	Non-inverting differential LVPECL clock input.
10	nPCLK	Input	Pullup/ Pulldown	Inverting differential LVPECL clock input. $V_{cc}/2$ default when left floating.
11	V _{cc}	Power		Core supply pin.
12	EXT_FB	Input	Pulldown	External feedback input.
13	nEXT_FB	Input	Pullup/ Pulldown	External feedback input. t. $V_{cc}/2$ default when left floating.
14	V _{CCA}	Power		Analog supply pin.
15 16	nQFB QFB	Output		Differential feedback output pair. LVPECL Interface levels.
17, 22, 30, 42	V _{cco}	Power		Output supply pins.
18, 19	nQD0, QD0	Output		Differential output pair. LVPECL interface levels.
20, 21	nQD1, QD1	Output		Differential output pair. LVPECL interface levels.
23, 24	nQC0, QC0	Output		Differential output pair. LVPECL interface levels.
25, 26	nQC1, QC1	Output		Differential output pair. LVPECL interface levels.
27 33 36 39	FSEL3 FSEL2 FSEL1 FSEL0	Input	Pulldown	Frequency select pins. LVCMOS/LVTTL interface levels.
28, 29	nQC2, QC2	Output		Differential output pair. LVPECL interface levels.
31, 32	nQB0, QB0	Output		Differential output pair. LVPECL interface levels.
34, 35	nQB1, QB1	Output		Differential output pair. LVPECL interface levels.
37, 38	nQB2, QB2	Output		Differential output pair. LVPECL interface levels.
40, 41	nQB3, QB3	Output		Differential output pair. LVPECL interface levels.
43, 44	nQA0, QA0	Output		Differential output pair. LVPECL interface levels.
45, 46	nQA1, QA1	Output		Differential output pair. LVPECL interface levels.
47, 48	nQA2, QA2	Output		Differential output pair. LVPECL interface levels.
49, 50	nQA3, QA3	Output		Differential output pair. LVPECL interface levels.
51	SYNC_SEL	Input	Pulldown	SYNC output select pin. When LOW, the SYNC otuput follows the timing diagram (page 5). When HIGH, QD output follows QC output.
52	VCO_SEL	Input	Pulldown	Selects VCO range. LVCMOS/LVTTL interface levels.

NOTE: Pullup and Pulldown refer to internal input resistors. See Table 2, Pin Characteristics, for typical values.

3

TABLE 2. PIN CHARACTERISTICS

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
C _{IN}	Input Capacitance			4		pF
R _{PULLDOWN}	Input Pulldown Resistor			51		kΩ
R _{PULLup}	Input Pullup Resistor			51		kΩ

Inputs Outputs FSEL3 FSEL2 FSEL1 FSEL0 0 0 0 0 ÷2 0 ÷2 0 0 1 0 0 1 0 ÷2 0 0 ÷2 1 1

TABLE 3A. SELECT PIN FUNCTION TABLE

QAx QBx QCx ÷2 ÷2 ÷2 ÷4 ÷4 ÷4 ÷2 ÷6 1 0 0 ÷2 0 ÷6 ÷6 0 1 0 1 ÷2 ÷4 ÷6 ÷4 ÷ 8 0 1 1 0 ÷2 ÷2 0 1 1 1 ÷6 ÷ 8 ÷2 ÷ 8 1 0 0 0 ÷2 ÷2 1 0 0 ÷ 8 ÷ 8 1 1 0 1 0 ÷4 ÷4 ÷6 1 ÷4 1 0 1 ÷6 ÷6 1 1 0 0 ÷4 ÷6 ÷ 8 1 1 0 1 ÷6 ÷6 ÷ 8 ÷ 8 1 1 1 0 ÷6 ÷8 1 1 1 1 ÷ 8 ÷ 8 ÷8

TABLE 3B. FEEDBACK CONTROL FUNCTION TABLE

	Inputs		Outputs
FSEL_FB2	FSEL_FB1	FSEL_FB0	QFB
0	0	0	÷2
0	0	1	÷4
0	1	0	÷6
0	1	1	÷8
1	0	0	÷8
1	0	1	÷16
1	1	0	÷24
1	1	1	÷32

TABLE 3C. INPUT CONTROL FUNCTION TABLE

Control Input Pin	Logic 0	Logic 1
PLL_EN	Enables PLL	Bypasses PLL
VCO_SEL	fVCO	fVCO/2
REF_SEL	Selects PCLK/nPCLK	Selects TEST_CLK
MR		Resets outputs
SYNC_SEL	Selects outputs	Match QC Outputs

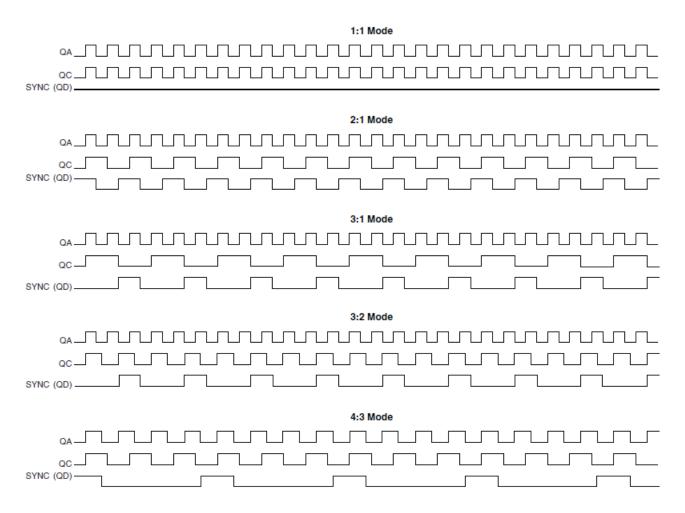


FIGURE 1. TIMING DIAGRAMS

Absolute Maximum Ratings

Supply Voltage, V _{cc}	4.6V
Inputs, V _I	-0.5V to V _{cc} + 0.5 V
Outputs, I _o	
Continuous Current Surge Current	50mA 100mA
Package Thermal Impedance, $\boldsymbol{\theta}_{_{JA}}$	42.3°C/W (0 lfpm)
Storage Temperature, $T_{_{STG}}$	-65°C to 150°C

NOTE: Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These ratings are stress specifications only. Functional operation of product at these conditions or any conditions beyond those listed in the *DC Characteristics* or *AC Characteristics* is not implied. Exposure to absolute maximum rating conditions for extended periods may affect product reliability.

Table 4A. Power Supply DC Characteristics, $V_{cc} = V_{cca} = V_{cco} = 3.3V \pm 5\%$, $V_{ee} = 0V$, Ta = 0°C to 70°C

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
V _{cc}	Core Supply Voltage		3.135	3.3	3.465	V
V _{CCA}	Analog Supply Voltage		3.135	3.3	3.465	
V _{cco}	Output Supply Voltage		3.135	3.3	3.465	V
I _{cc}	Power Supply Current				150	mA
I _{cca}	Analog Supply Current				15	mA
I _{cco}	Output Supply Current				95	mA

TABLE 4B. LVCMOS/LVTTL DC CHARACTERISTICS, $V_{CC} = V_{CCA} = V_{CCO} = 3.3V \pm 5\%$, $V_{EE} = 0V$, TA = 0°C to 70°C

Symbol	Parameter		Test Conditions	Minimum	Typical	Maximum	Units
V _{IH}	Input High Voltage	PLL_EN, VCO_SEL, REF_SEL, SYNC_SEL, FSEL_FB0:FSEL_FB2, FSEL0:FSEL3, MR		2		V _{cc} +0.3	V
		TEST_CLK		2		V _{cc} + 0.3	V
V _{IL}	Input Low Voltage	PLL_EN, VCO_SEL, REF_SEL, SYNC_SEL, FSEL_FB0:FSEL_FB2, FSEL0:FSEL3, MR		-0.3		0.8	V
		TEST_CLK		-0.3		1.3	V
I _{IH}	Input High Current		$V_{\rm CC} = V_{\rm IN} = 3.465 V$			150	μA
I	Input Low Current		$V_{_{\rm IN}} = 0V, V_{_{\rm CC}} = 3.465V$	-5			μA

Table 4C. LVPECL DC Characteristics, $V_{CC} = V_{CCA} = V_{CCO} = 3.3V \pm 5\%$, $V_{EE} = 0V$, $T_A = 0^{\circ}C$ to $70^{\circ}C$

Symbol	Parameter		Test Conditions	Minimum	Typical	Maximum	Units
	Input High Current	PCLK	$V_{\rm CC} = V_{\rm IN} = 3.465 V$			150	μA
чн	Input High Current	nPCLK	$V_{\rm CC} = V_{\rm IN} = 3.465 V$			5	μA
		PCLK	V _{cc} = 3.465V, V _{IN} = 0V	-5			μA
IIL.	Input Low Current	nPCLK	V _{cc} = 3.465V, V _{IN} = 0V	-150			μA
V _{PP}	Peak-to-Peak Input	Voltage		0.3		1	V
V _{CMR}	Common Mode Inpu	ut Voltage; NOTE 1, 2		V _{EE} + 1.5		V _{cc}	V
V _{OH}	Output High Voltage	; NOTE 3		V _{cc} - 1.4		V _{cc} - 0.9	V
V _{ol}	Output Low Voltage;	NOTE 3		V _{cc} - 2.0		V _{cc} - 1.7	V
V _{SWING}	Peak-to-Peak Outpu	It Voltage Swing		0.6		1	V

NOTE 1: Common mode voltage is defined as V_{III}.

NOTE 2: For single ended applications, the maximum input voltage for PCLK, nPCLK is V_{cc} + 0.3V.

NOTE 3: Outputs terminated with 50 Ω to V_{cco} - 2V. .

Symbol	Parameter		Test Conditions	Minimum	Typical	Maximum	Units
t _R / t _R	Input Rise/Fall Time	TEST_CLK				3	ns
			Feedback ÷ 6	66.66		133.33	MHz
			Feedback ÷ 8	50		100	MHz
	Reference Frequency VCO_SEL = 0		Feedback ÷ 16	25		50	MHz
	000_022 = 0		Feedback ÷ 24	16.66		33.33	MHz
			Feedback ÷ 32	12.5		25	MHz
f _{REF}			Feedback ÷ 4	50		100	MHz
			Feedback ÷ 6	33.33		66.66	MHz
	Reference Frequency		Feedback ÷ 8	25		50	MHz
	VCO_SEL = 1		Feedback ÷ 16	12.5		25	MHz
			Feedback ÷ 24	8.33		16.66	MHz
			Feedback ÷ 32	6.25		12.5	MHz
f _{REFDC}	Reference Input Duty C	ycle		25		75	%

Table 5. PLL Input Reference Characteristics, $V_{cc} = V_{cca} = V_{cco} = 3.3V \pm 5\%$, Ta = 0°C to 70°C

NOTE: These parameters are guaranteed by design, but are not tested in production.

TABLE 6. AC CHARACTERISTICS,	$V_{CC} = V$	$V_{CCA} = V_{CC}$	$_{co} = 3.3V \pm 5\%$	$T_A = 0^{\circ}C$ to $70^{\circ}C$
------------------------------	--------------	--------------------	------------------------	-------------------------------------

Symbol	Parameter		Test Conditions	Minimum	Typical	Maximum	Units
f _{MAX}	Output Frequency					400	MHz
t(Ø)	Static Phase Offset; NOTE 1, 5	PCLK, nPCLK		0	170	325	ps
tsk(o)	Output Skew; NOTE 2	2, 3				250	ps
tsk(w)	Multiple Frequency S	kew; NOTE 3, 6				350	ps
tjit(cc)	Cycle-to-Cycle Jitter;	NOTE 3			±50		ps
£			PLL_SEL = 0	400		800	MHz
t _{vco}	PLL VCO Lock Range	e, NOTE 4	PLL_SEL = 1	200		400	MHz
t _{LOCK}	PLL Lock Time					10	ms
t _R / t _F	Output Rise/Fall Time)	20% to 80%	0.2		1	ns
odc	Output Duty Cycle			45		55	%

All parameters measured at $\mathbf{f}_{_{\rm MAX}}$ unless noted otherwise.

NOTE 1: Defined as the time difference between the input reference clock and the average feedback input signal when the PLL is locked and the input reference frequency is stable.

NOTE 2:Defined as skew between outputs at the same supply voltage and with equal load conditions.

Measured at the output differential cross points.

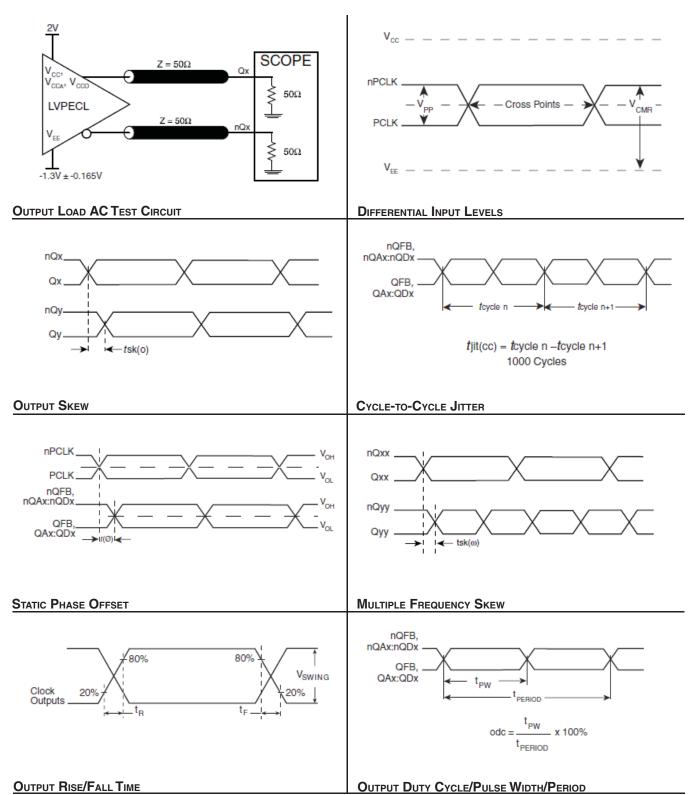
NOTE 3: This parameter is defined in accordance with JEDEC Standard 65.

NOTE 4: When VCO_SEL = 0, the PLL will be unstable with feedback configurations of $\div 2$, $\div 4$ and some $\div 6$.

When VCO_SEL = 1, the PLL will be unstable with a feedback configuration of $\div 2$.

NOTE 5: Static phase offset is specified for an input frequency of 50MHz with feedback in ÷8.

NOTE 6: Defined as skew across banks of outputs switching in the same direction operating at different frequencies with the same supply voltages and equal load conditions. Measured at $V_{cco}/2$.



PARAMETER MEASUREMENT INFORMATION



APPLICATION INFORMATION

POWER SUPPLY FILTERING TECHNIQUES

As in any high speed analog circuitry, the power supply pins are vulnerable to random noise. The 873991 provides separate power supplies to isolate any high switching noise from the outputs to the internal PLL. V_{cC} , V_{cCA} , and V_{cCO} should be individually connected to the power supply plane through vias, and bypass capacitors should be used for each pin. To achieve optimum jitter performance, power supply isolation is required. *Figure 2* illustrates how a 10 Ω resistor along with a 10 μ F and a .01 μ F bypass capacitor should be connected to each V_{cCA} pin.

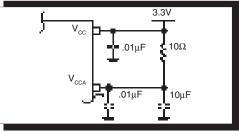
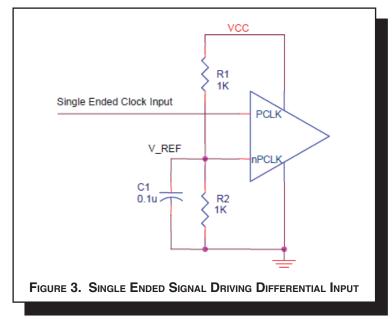


FIGURE 2. POWER SUPPLY FILTERING

WIRING THE DIFFERENTIAL INPUT TO ACCEPT SINGLE ENDED LEVELS

Figure 3 shows how the differential input can be wired to accept single ended levels. The reference voltage V_REF = $V_{cc}/2$ is generated by the bias resistors R1, R2 and C1. This bias circuit should be located as close as possible to the input pin. The ratio

of R1 and R2 might need to be adjusted to position the V_REF in the center of the input voltage swing. For example, if the input clock swing is only 2.5V and V_{cc} = 3.3V, V_REF should be 1.25V and R2/R1 = 0.609.



TERMINATION FOR 3.3V LVPECL OUTPUTS

The clock layout topology shown below is a typical termination for LVPECL outputs. The two different layouts mentioned are recommended only as guidelines.

FOUT and nFOUT are low impedance follower outputs that generate ECL/LVPECL compatible outputs. Therefore, terminating resistors (DC current path to ground) or current sources must be used for functionality. These outputs are designed to

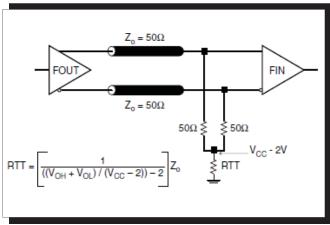


FIGURE 4A. LVPECL OUTPUT TERMINATION

drive 50 Ω transmission lines. Matched impedance techniques should be used to maximize operating frequency and minimize signal distortion. *Figures 4A and 4B* show two different layouts which are recommended only as guidelines. Other suitable clock layouts may exist and it would be recommended that the board designers simulate to guarantee compatibility across all printed circuit and clock component process variations.

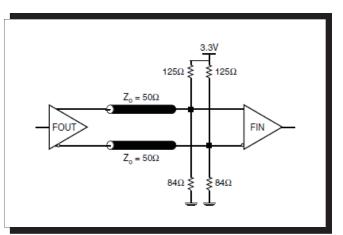


FIGURE 4B. LVPECL OUTPUT TERMINATION

LVPECL CLOCK INPUT INTERFACE

The PCLK /nPCLK accepts LVPECL, CML, SSTL and other differential signals. Both V_{SWING} and V_{OH} must meet the V_{PP} and V_{OMR} input requirements. *Figures 5A to 5D* show interface examples for the PCLK/nPCLK input driven by the most common driver types. The input interfaces suggested here

are examples only. If the driver is from another vendor, use their termination recommendation. Please consult with the vendor of the driver component to confirm the driver termination requirements.

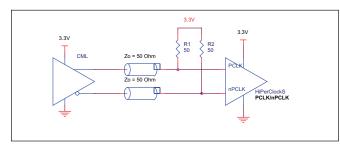


FIGURE 5A. PCLK/nPCLK INPUT DRIVEN BY A CML DRIVER

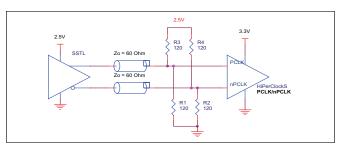


FIGURE 5B. PCLK/nPCLK INPUT DRIVEN BY AN SSTL DRIVER

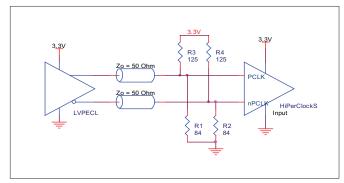


FIGURE 5C. PCLK/nPCLK INPUT DRIVEN BY A 3.3V LVPECL DRIVER

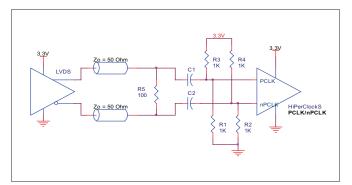


FIGURE 5D. PCLK/nPCLK INPUT DRIVEN BY A 3.3V LVDS DRIVER



Power Considerations

This section provides information on power dissipation and junction temperature for the 873991. Equations and example calculations are also provided.

1. Power Dissipation.

The total power dissipation for the 873991 is the sum of the core power plus the power dissipated in the load(s). The following is the power dissipation for $V_{cc} = 3.3V + 5\% = 3.465V$, which gives worst case results. **NOTE:** Please refer to Section 3 for details on calculating power dissipated in the load.

- Power (core)_{MAX} = V_{CC MAX} * I_{EE MAX} = 3.465V * 165mA = **571.7mW**
- Power (outputs)_{MAX} = 30mW/Loaded Output pair
 If all outputs are loaded, the total power is 14 * 30mW = 420mW

Total Power MAX (3.465V, with all outputs switching) = 571.7mW + 420mW = 991.7mW

2. Junction Temperature.

Junction temperature, Tj, is the temperature at the junction of the bond wire and bond pad and directly affects the reliability of the device. The maximum recommended junction temperature for the devices is 125°C.

The equation for Tj is as follows: $Tj = \theta_{JA} * Pd_{total} + T_A$

Tj = Junction Temperature

 θ_{JA} = Junction-to-Ambient Thermal Resistance

Pd_total = Total Device Power Dissipation (example calculation is in section 1 above)

T_A = Ambient Temperature

In order to calculate junction temperature, the appropriate junction-to-ambient thermal resistance θ_{JA} must be used. Assuming a moderate air flow of 200 linear feet per minute and a multi-layer board, the appropriate value is 47.1°C/W per Table 7 below.

Therefore, Tj for an ambient temperature of 70°C with all outputs switching is:

 $70^{\circ}C + 0.992W * 47.1^{\circ}C/W = 116.7^{\circ}C$. This is below the limit of $125^{\circ}C$.

This calculation is only an example. Tj will obviously vary depending on the number of loaded outputs, supply voltage, air flow, and the type of board (single layer or multi-layer).

TABLE 7. THERMAL RESISTANCE θ_{JA} FOR 52-PIN LQFP, FORCED CONVECTION

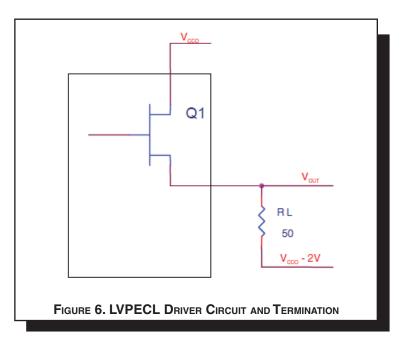
θJA by Velocity (Linear Feet per Minute)				
Single-Layer PCB, JEDEC Standard Test Boards	0 58.0°C/W	200 47.1°C/W	500 42.0°C/W	
Julti-Layer PCB, JEDEC Standard Test Boards	42.3°C/W	36.4°C/W	34.0°C/W	

NOTE: Most modern PCB designs use multi-layered boards. The data in the second row pertains to most designs.

3. Calculations and Equations.

The purpose of this section is to derive the power dissipated into the load.

LVPECL output driver circuit and termination are shown in Figure 6.



To calculate worst case power dissipation into the load, use the following equations which assume a 50 Ω load, and a termination voltage of V_{cco}- 2V.

• For logic high, $V_{OUT} = V_{OH_MAX} = V_{CCO_MAX} - 0.9V$

 $(V_{CCO_{MAX}} - V_{OH_{MAX}}) = 0.9V$

• For logic low, $V_{OUT} = V_{OL_{MAX}} = V_{CCO_{MAX}} - 1.7V$

 $(V_{CCO_MAX} - V_{OL_MAX}) = 1.7V$

Pd_H is power dissipation when the output drives high. Pd_L is the power dissipation when the output drives low.

 $Pd_{H} = [(V_{OH_{MAX}} - (V_{CCO_{MAX}} - 2V))/R_{L}] * (V_{CCO_{MAX}} - V_{OH_{MAX}}) = [(2V - (V_{CCO_{MAX}} - V_{OH_{MAX}}))/R_{L}] * (V_{CCO_{MAX}} - V_{OH_{MAX}}) = [(2V - 0.9V)/50\Omega] * 0.9V = 19.8mW$

 $Pd_{L} = [(V_{OL_{MAX}} - (V_{CCO_{MAX}} - 2V))/R_{L}] * (V_{CCO_{MAX}} - V_{OL_{MAX}}) = [(2V - (V_{CCO_{MAX}} - V_{OL_{MAX}}))/R_{L}] * (V_{CCO_{MAX}} - V_{OL_{MAX}}) = [(2V - 1.7V)/50\Omega] * 1.7V = 10.2mW$

Total Power Dissipation per output pair = Pd_H + Pd_L = **30mW**

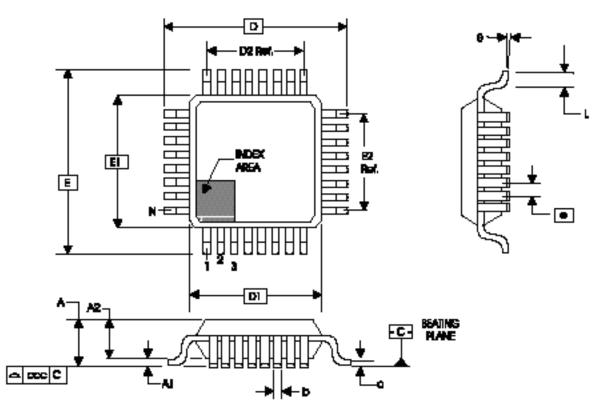
RELIABILITY INFORMATION

TABLE 8. $\boldsymbol{\theta}_{JA} \text{vs.}$ Air Flow Table for 52 Lead LQFP

	0	200	500
Single-Layer PCB, JEDEC Standard Test Boards	58.0°C/W	47.1°C/W	42.0°C/W
Multi-Layer PCB, JEDEC Standard Test Boards	42.3°C/W	36.4°C/W	34.0°C/W

TRANSISTOR COUNT The transistor count for 873991 is: 5788

PACKAGE OUTLINE - Y SUFFIX FOR 52 LEAD LQFP



JEDEC VARIATION ALL DIMENSIONS IN MILLIMETERS				
SYMBOL	BCC			
STMBOL	MINIMUM	NOMINAL	MAXIMUM	
N	52			
А		1.60		
A1	0.05		0.15	
A2	1.35	1.40	1.45	
b	0.22	0.32	0.38	
с	0.09		0.20	
D	12.00 BASIC			
D1	10.00 BASIC			
E	12.00 BASIC			
E1	10.00 BASIC			
е	0.65 BASIC			
L	0.45		0.75	
θ	0° 7°			
ccc	0.08			

Reference Document: JEDEC Publication 95, MS-026

TABLE 10. ORDERING INFORMATION

Part/Order Number	Marking	Package	Shipping Packaging	Temperature
873991AYLF	ICS873991AYLF	52 Lead "Lead-Free" LQFP	tray	0°C to 70°C
873991AYLFT	ICS873991AYLF	52 Lead "Lead-Free" LQFP	tape & reel	0°C to 70°C

NOTE: Parts that are ordered with an "LF" suffix to the part number are the Pb-Free configuration and are RoHS compliant.

	REVISION HISTORY SHEET						
Rev	Table	Page	Description of Change	Date			
А	T10	1 16	Features Section - added Lead-Free bullet. Ordering Information Table - added Lead-Free part number and note.	6/13/05			
А	T10	16 18	Updated datasheet's header/footer with IDT from ICS. Removed ICS prefix from Part/Order Number column. Added LF marking. Added Contact Page.	7/25/10			
А			Product Discontinuation Notice - Last time buy expires August 14, 2016. PDN CQ-15-04	8/25/15			



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